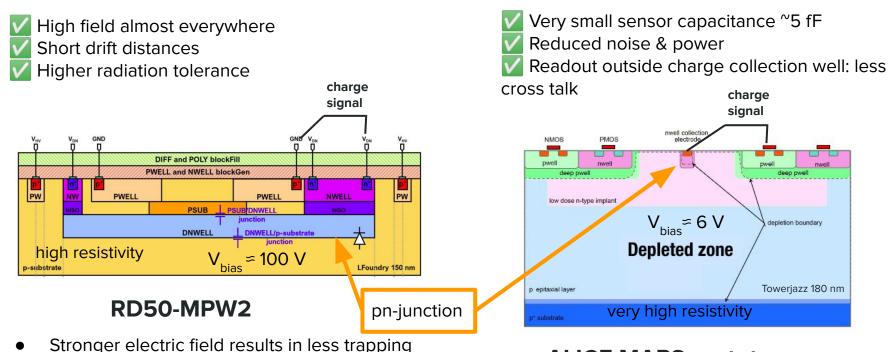
Time resolution of the RD50-MPW2 HV CMOS

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Depleted MAPS: small and large collection electrodes



and higher radiation tolerance

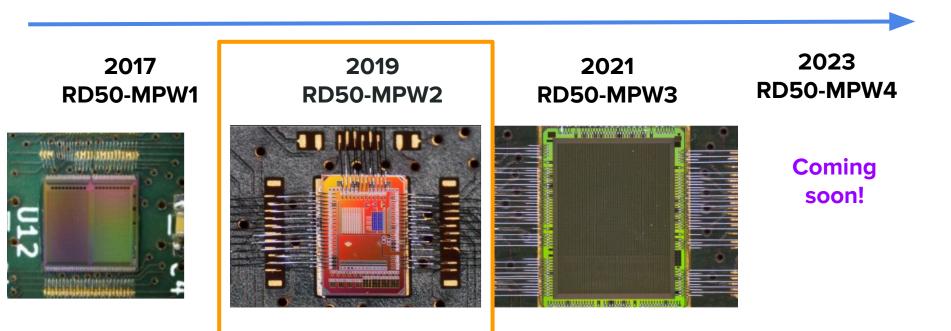
Larger electric field comes at a cost: more

capacitance, power and more noise

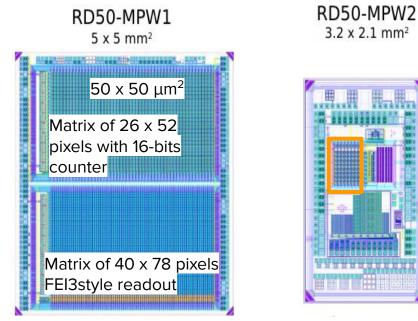
- **ALICE MAPS** prototypes
 - From E. Vilella, Vertex2018

RD50 CMOS development

See also overview talk by Eva Vilella

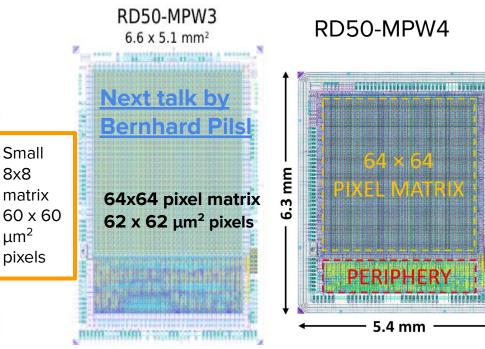


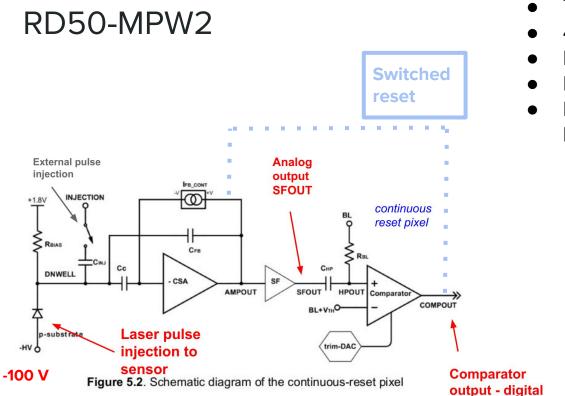
Four submissions of RD50 HV CMOS monolithic sensors



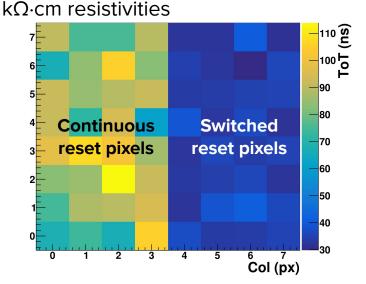
Low breakdown V_{bd} ≈ 60 V High leakage current I_{leak}~µA







- Two pixel flavors
- 4-bit trim DAC
- Large variety of test structures
- Depletion depths of ~190 μm
- Produced in 1.9 k Ω ·cm and 3.0



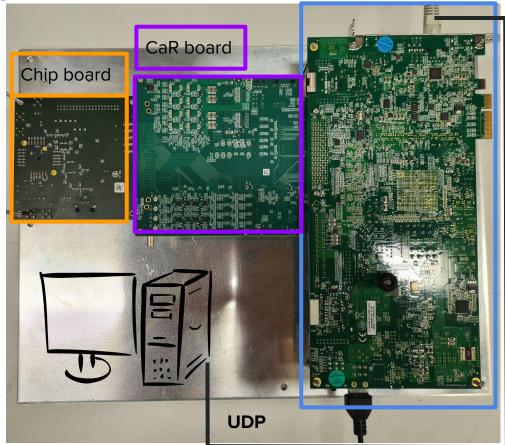
- Continuous reset ToT scales with signal size
- Switched reset much faster reset

Data acquisition of RD50-MPW2

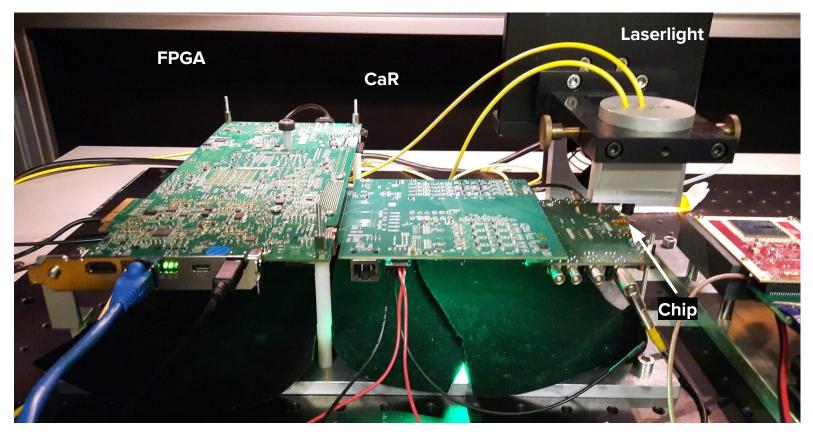
Zilinx ZC706 FPGA



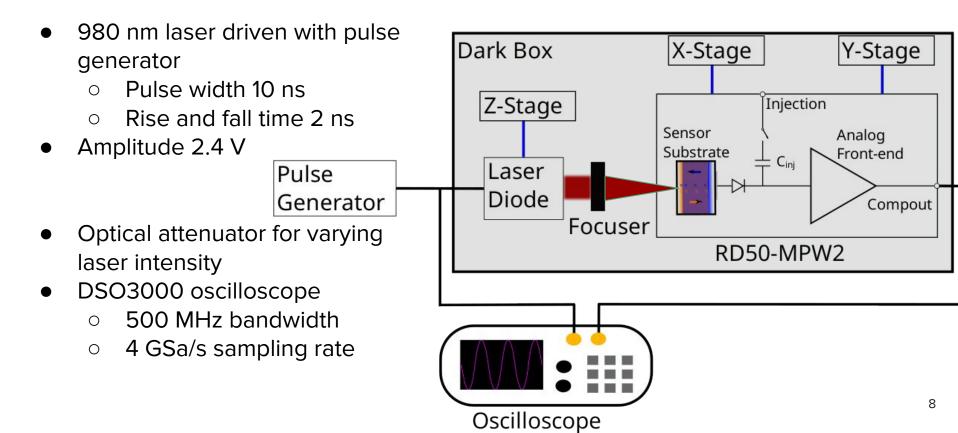
- <u>Caribou</u> used for powering
- ZYNQ-ZC706 with Yocto based linux



Back-TCT measurements at Nikhef

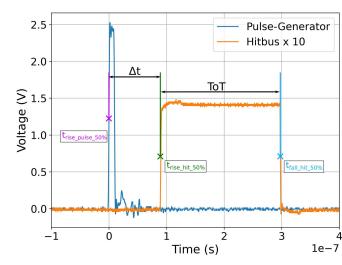


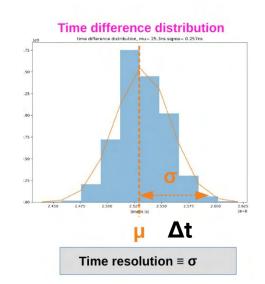
Back-TCT measurements at Nikhef

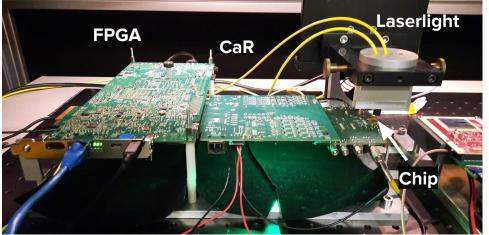


Time resolution

Laser pulse injected with various intensities



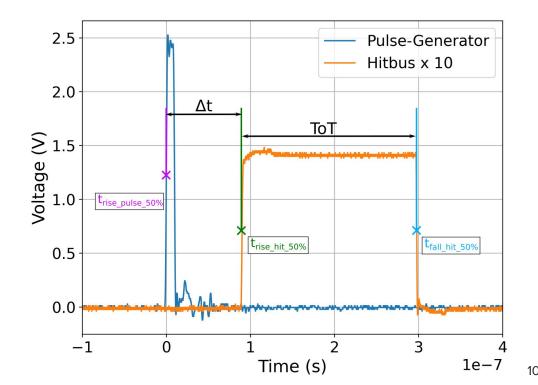




The spread in the time difference between the pulse sent to the laser and the comparator output from the chip gives the time resolution

Time resolution measurement

- All measurement points are at 50% constant fraction
- ToT = t_{fall_hit_50%} t_{rise_hit_50%}
- First point of signal is relevant value for time measurement:
- Laser measurements
- $\Delta t = t_{rise_hit_50\%} t_{rise_pulse_50\%}$
- Test pulse measurements
- $\Delta t = t_{rise_hit_50\%} t_{fall_pulse_50\%}$



Threshold and calibration

Threshold:

- Threshold 1000 mV with a baseline of 900 mV
- Row (px) Performed threshold equalization (trimming)
- Switched reset pixels: 1460 e⁻
- Continuous reset pixels: 2980 e⁻

Charge calibration:

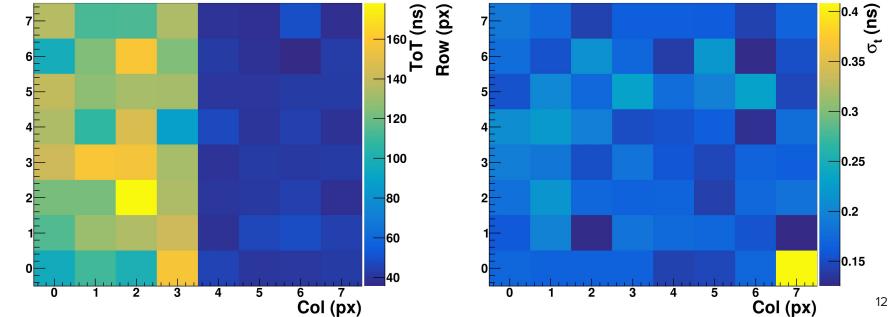
- For continuous pixels time over threshold \propto charge
- Charge calibrated with time over threshold from charge injection at different voltages

-100 V/

\/

Electronics circuit contribution to time resolution

- Charge of 12100 e⁻ injected through injection capacitance bypassing the pixel sensor
- Time resolution from electronics only is 200 ps



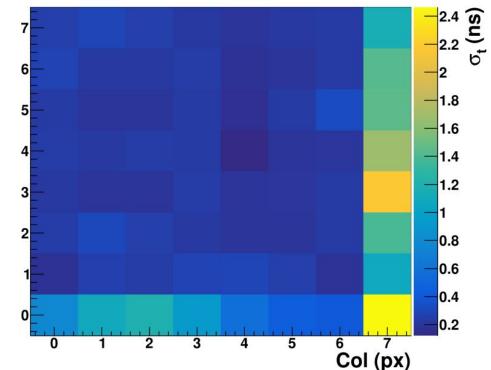
Row (px)

Time resolution for RD50-MPW2 pixel matrix

- $V_{bias} = 100 V$
- Row (px MIP-like charge of 12100 e equivalent charge injection via laser centered on each pixel:

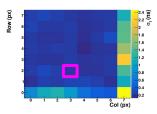
 $\sigma_{t, \text{ switched}} = 211 \pm 45 \text{ ps}$ $\sigma_{t, \text{ continuous}} = 227 \pm 27 \text{ ps}$

Switched reset pixels have a slightly better time resolution

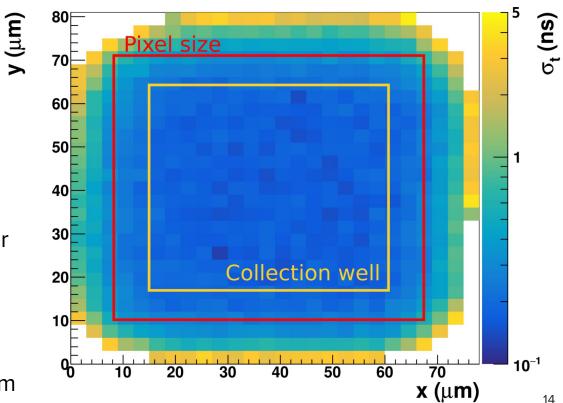


In-pixel time resolution

- Scan in 3 µm steps
- Continuous pixel (3,2)

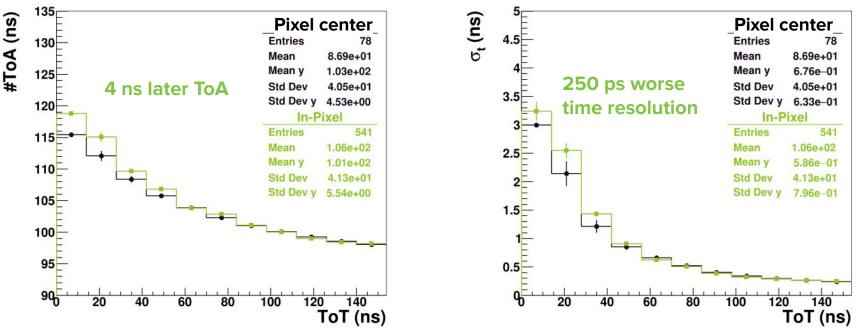


- Better time resolution under collection well: $\sigma_{t, \text{ well}} = 250 \pm 42 \text{ ps}$
 - $\sigma_{t, \text{ pixel}} = 267 \pm 56 \text{ ps}$
- Charge sharing up to [~]10 μm beyond pixel boundary



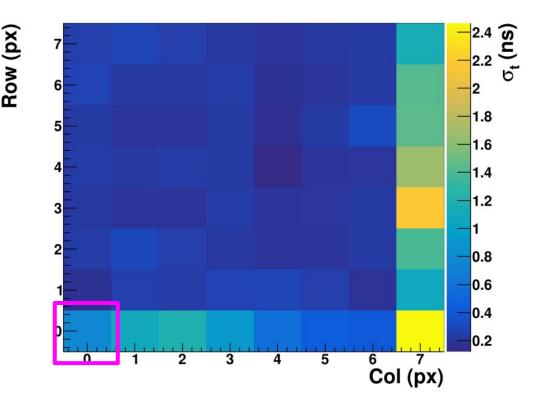
In-pixel vs pixel center ToA and time resolution

- In-pixel scan over entire pixel
- Scan at center of pixel varying charge by attenuating laser signal
- Overlap at high ToT values: in-pixel scan over center
- Below ToT = 150 ns: fluctuations from inhomogeneous charge collection times



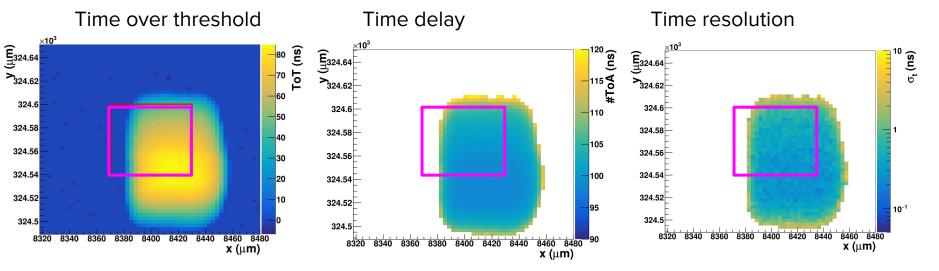
Time resolution for RD50-MPW2 pixel matrix

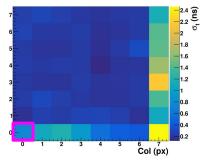
- Effect in row 0 and column
 7 was also seen in other
 chips
- In-pixel scan of continuous pixel at border to investigate worse time resolution
- This effect is no longer seen in RD50-MPW3 and is not expected in RD50-MPW4.

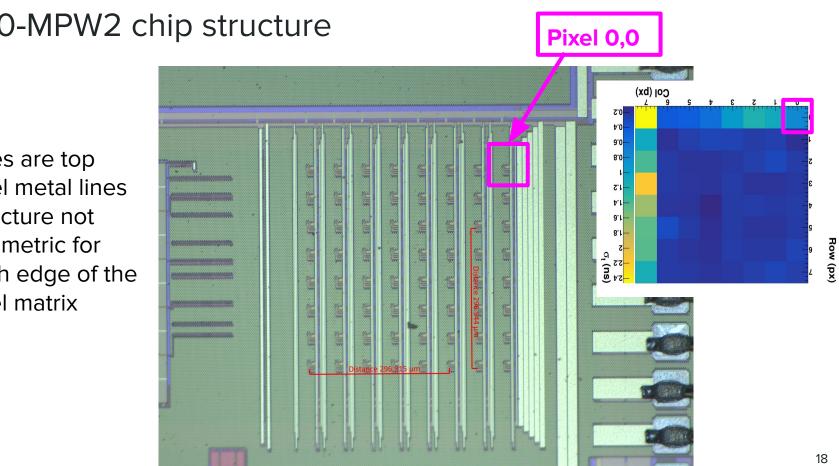


In-pixel measurement (0,0)

- Pixel shape is skewed
- Electric field not symmetric: uncontained only in one direction





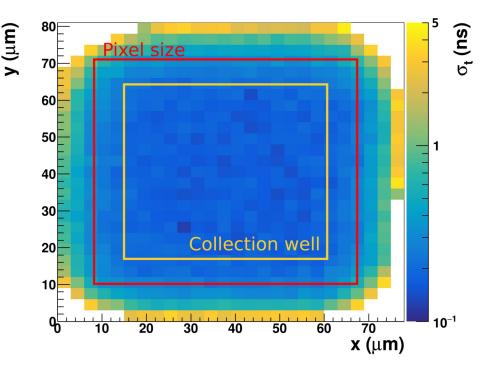


RD50-MPW2 chip structure

- Lines are top level metal lines
- Structure not symmetric for each edge of the pixel matrix

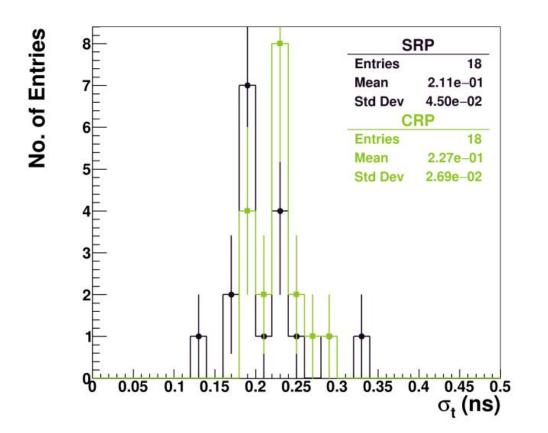
Summary and outlook

- RD50 HV CMOS not optimized for fast timing can achieve 227 ps time resolution for a MIP-like charge
- The electronics contribution to the time resolution is 220 ps
- A first in-pixel scan of RD50-MPW2 shows quite homogeneous time resolution over entire pixel
- MPW3 results shown <u>last meeting</u>
- Expect improved results in RD50-MPW4 that will arrive soon.



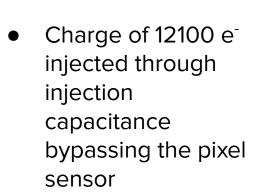
Additional material

Time resolution for switched vs continuous reset pixels

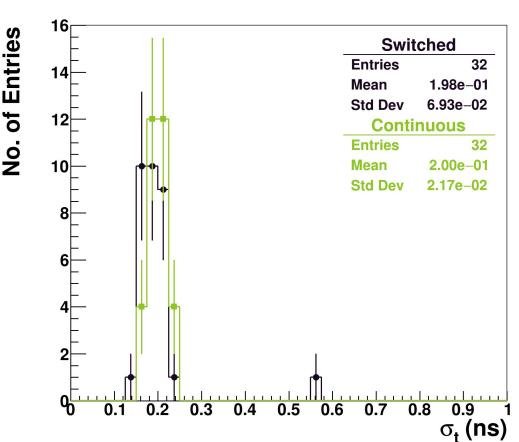


- 12100 e⁻ equivalent charge injection via laser centered on each pixel
- Charge calibrated with time over threshold from charge injection at different voltages

Time resolution for electronics only



 Time resolution from electronics only is 200 ps



Time resolution measurement

- All measurement points are at 50% constant fraction
- ToT = t_{fall_hit_50%} t_{rise_hit_50%}

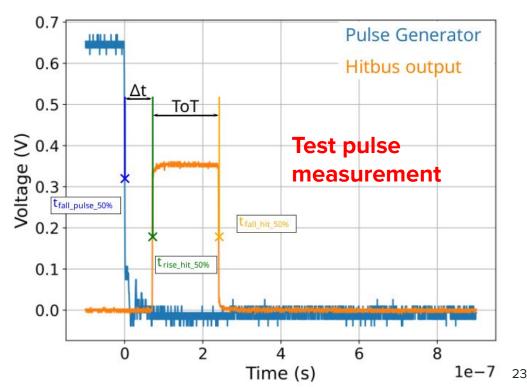
First point of signal is relevant value for time measurement:

Laser measurements

• $\Delta t = t_{rise_hit_50\%} - t_{rise_pulse_50\%}$

Test pulse measurements

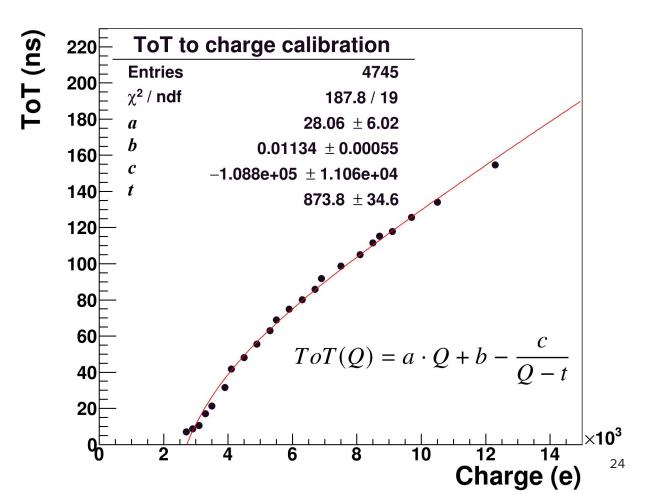
• $\Delta t = t_{rise_hit_50\%} - t_{fall_pulse_50\%}$



Charge calibration

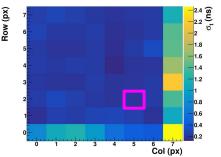
- Voltage step function with amplitude U_{ini}
- Connected to injection capacitance C_{inj} = 2.8 fF
- Injected charge: $Q_{inj} = C_{inj}U_{inj}$

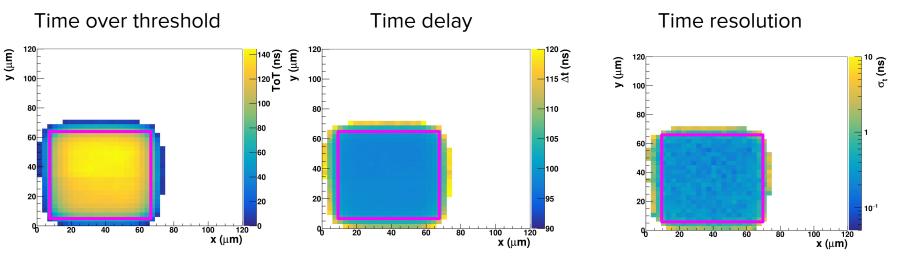
Time over threshold to charge conversion from fit to measured ToT by varying $U_{\rm inj}$



In-pixel measurement: (5,2)

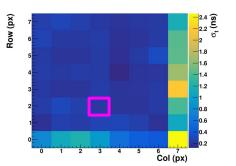
- Charge sharing appears to be reduced relative to continuous pixel
- ToT appears to increase halfway through the pixel, possibly resulting from laser fluctuations

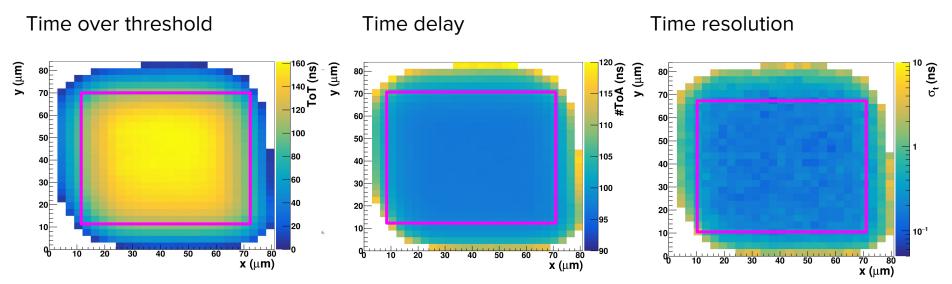




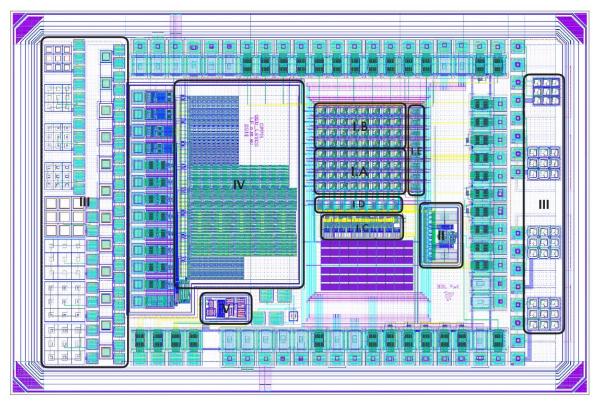
In-pixel measurement: (3,2)

 Continuous pixel gathers charge ~10 μm beyond pixel "boundary"



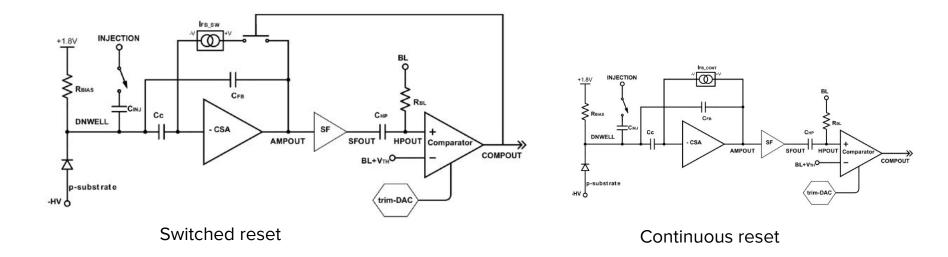


RD50-MPW2 layout



I. 8 × 8 Analog pixel matrix with pixel size of 60 μ m × 60 μ m, two flavors: I.A.Continuous-reset pixels (column 0 to 3) I.B. Switched-reset pixels (column 4 to 7) I.C. Bias block I.D. Row configuration registers I.E. Column configuration registers II. Analog buffer III. Test structures IV. SEU tolerant memory V. Bandgap 27

RD50-MPW2 frontend

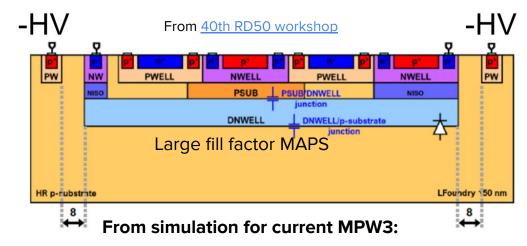


Measured performance of RD50-MPW2

Measured in previous MPW2:

- ENC < 50 e-
- Time-walk < 10 ns
- Leakage 120 pA/pixel
- ToT 30 ns
- Breakdown 120 V

Collection electrode size: 40 µm in MPW2 42 µm in MPW3



Pixel size	$62 \ \mu m imes 62 \ \mu m$	
Cd	~ 250 fF	
Power	$22 \mu W/\text{pixel}$ (VDD = 1.8	8 V)
Gain	230 mV (for 5 ke ⁻)	
ТоТ	55 ns (for 5 ke ⁻)	
ENC	120 e-	
Time walk	9 ns	